



Mini-Circuits

SURFACE MOUNT

RF Transformer

50Ω

5 to 300 MHz

TC3-1T+

Upgraded Version*
TC3-1TX+

*Addition of Top Hat® feature Benefits

- Allows faster pick-and-place
- Enables visual identification marking

FEATURES

- Excellent amplitude unbalance (0.3 dB typ) and phase unbalance (5 deg. typ) in 1 dB bandwidth
- Plastic base with leads
- Good return loss
- Aqueous washable



Generic photo used for illustration purposes only

CASE STYLE: AT224-1

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Impedance matching
- Balanced antennas

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio (secondary / primary)			3		
Frequency Range		5		300	MHz
Insertion Loss*	—		3		dB
	—		2		
	5-300		1		

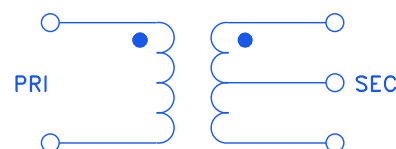
* Insertion Loss is referenced to mid-band loss, 0.4 dB typ.

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

CONFIG. A



REV. F
ECO-015303
TC3-1T+
MCL NY
220913



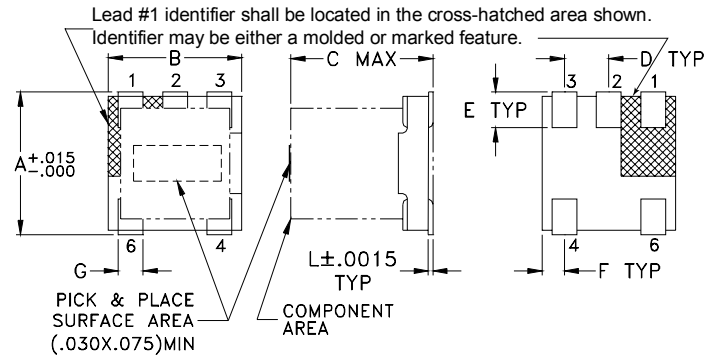


PIN CONNECTIONS

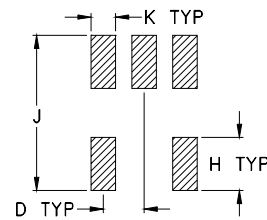
PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
SECONDARY CT	2

PRODUCT MARKING: NA

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm.002$

OUTLINE DIMENSIONS (Inch/mm)

A	B	C	D	E	F	G	H	J	K	L
.150	.150	.160	.050	.040	.025	.028	.065	.190	.030	.007
3.81	3.81	4.06	1.27	1.02	0.64	0.71	1.65	4.83	0.76	0.18

Weight: 0.15 grams

TAPE & REEL INFORMATION: F17



SURFACE MOUNT

RF Transformer

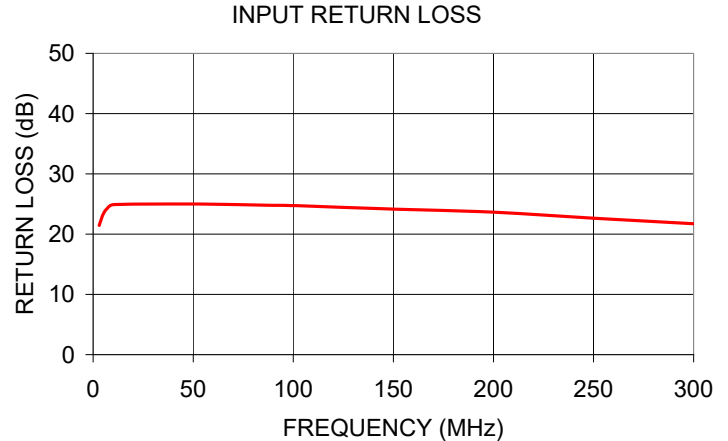
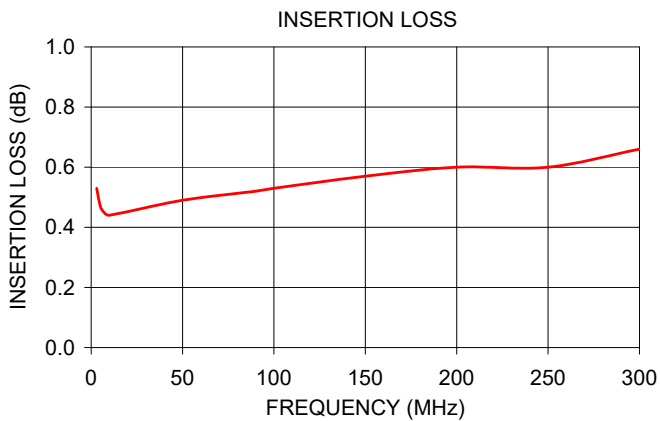
TC3-1T+

50 Ω

5 to 300 MHz

TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
3.00	0.53	21.45
7.00	0.45	24.23
10.00	0.44	24.89
50.00	0.49	24.99
90.00	0.52	24.79
100.00	0.53	24.74
150.00	0.57	24.15
200.00	0.60	23.65
250.00	0.60	22.64
300.00	0.66	21.73



NOTES

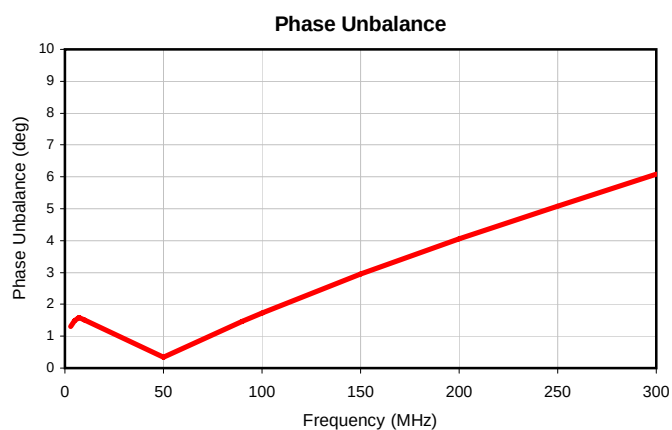
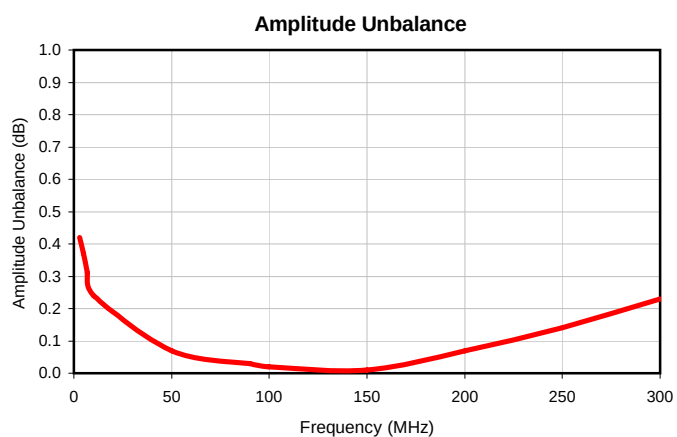
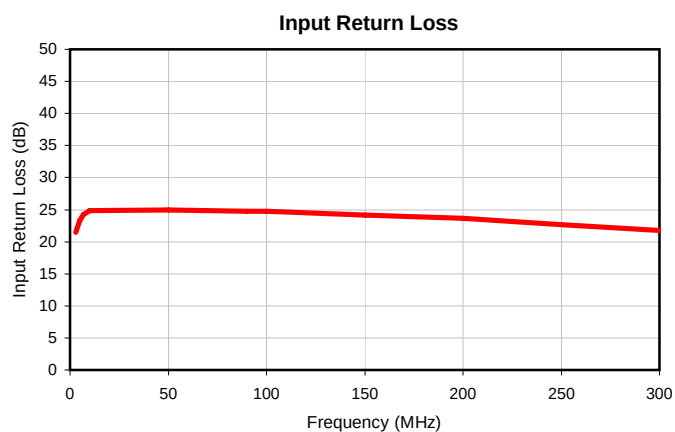
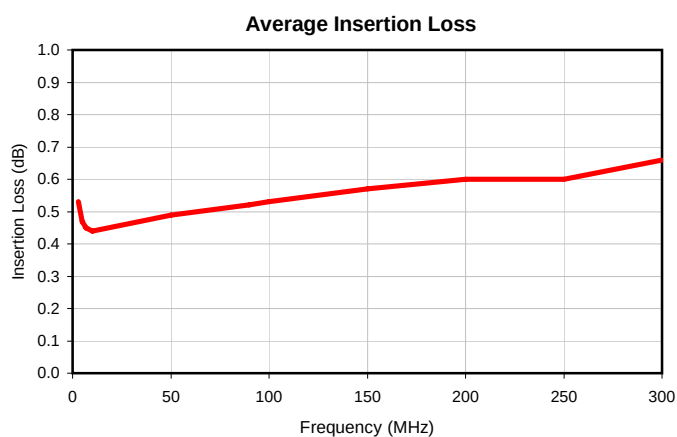
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Typical Performance Data

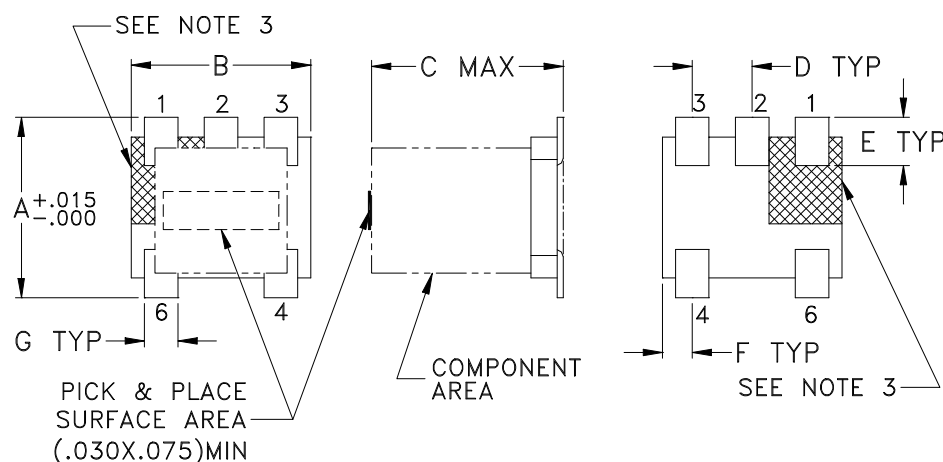
FREQUENCY MHz	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
3.0	0.53	21.45	0.42	1.31
5.0	0.47	23.29	0.37	1.48
7.0	0.45	24.23	0.31	1.58
10.0	0.44	24.89	0.24	1.51
50.0	0.49	24.99	0.07	0.34
90.0	0.52	24.79	0.03	1.46
100.0	0.53	24.74	0.02	1.72
150.0	0.57	24.15	0.01	2.95
200.0	0.60	23.65	0.07	4.06
250.0	0.60	22.64	0.14	5.08
300.0	0.66	21.73	0.23	6.09

Typical Performance Data

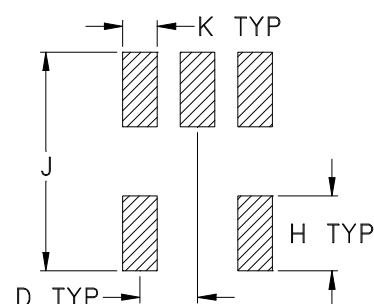


Outline Dimensions

AT224-1A



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm.002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAMS
AT224-1A	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
- Lead #1 identifier shall be located in the cross-hatched area shown.
Identifier may be either a molded or marked feature.



P.O. Box 350186, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

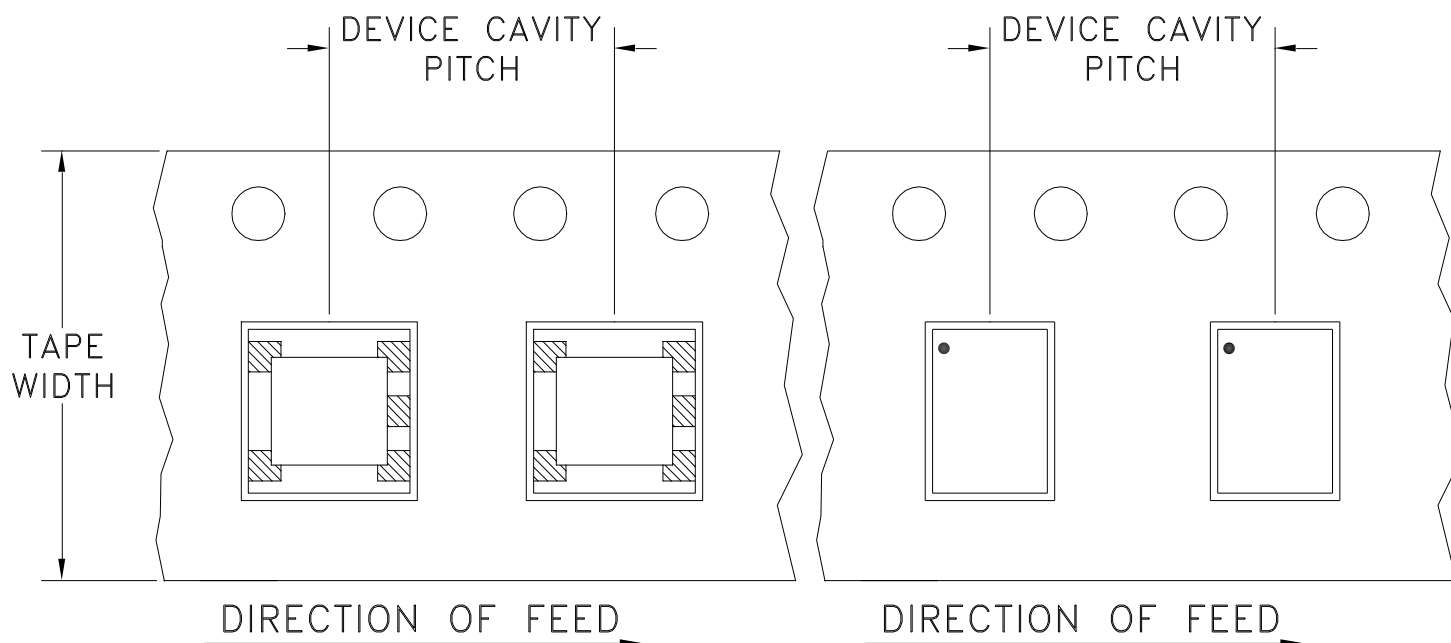


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



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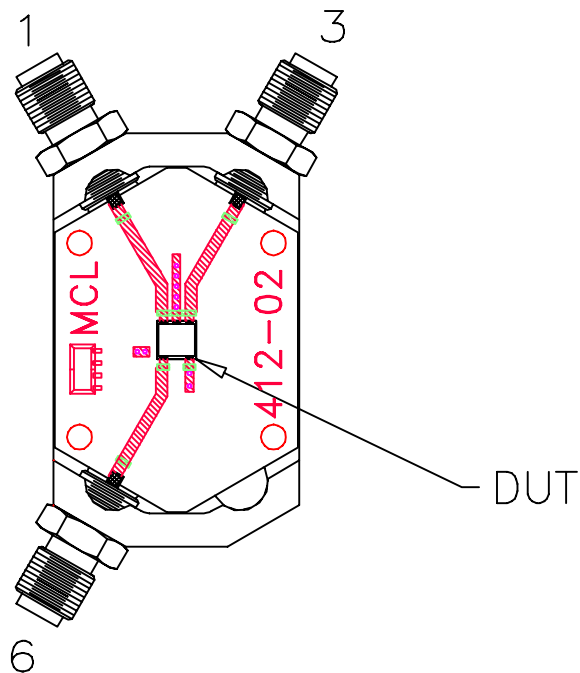


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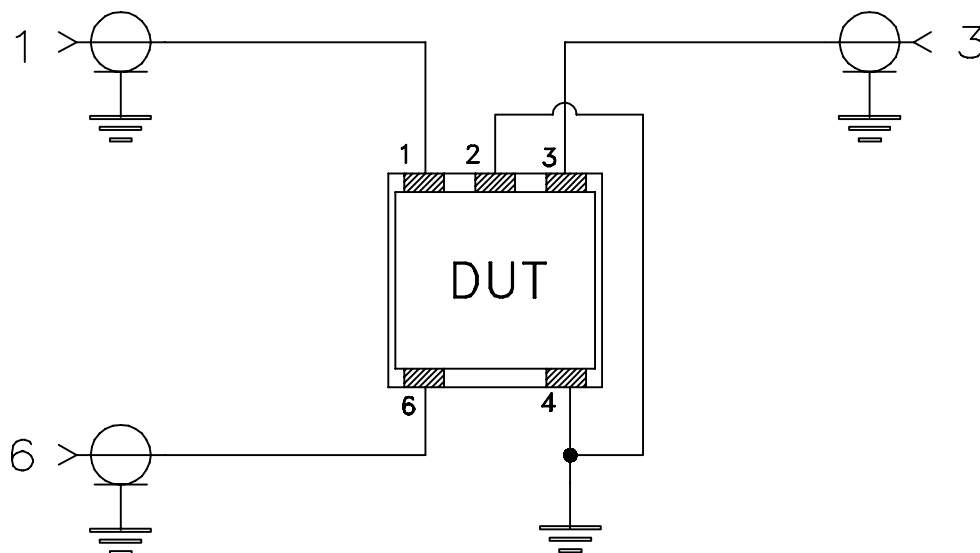
RF/IF MICROWAVE COMPONENTS

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215